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Hex Schmitt Inverter

The MC74VHCT14A is an advanced high speed CMOS Schmitt inverter fabricated with silicon gate CMOS technology. It achieves high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

Pin configuration and function are the same as the MC74VHCT04A, but the inputs have hysteresis and, with its Schmitt trigger function, the VHCT14A can be used as a line receiver which will receive slow input signals.

The VHCT inputs are compatible with TTL levels. This device can be used as a level converter for interfacing 3.3 V to 5.0 V, because it has full 5.0 V CMOS level output swings.

The VHCT14A input structures provide protection when voltages between 0 V and 5.5 V are applied, regardless of the supply voltage. The output structures also provide protection when $V_{CC} = 0$ V. These input and output structures help prevent device destruction caused by supply voltage – input/output voltage mismatch, battery backup, hot insertion, etc.

The internal circuit is composed of three stages, including a buffer output which provides high noise immunity and stable output. The inputs tolerate voltages up to 7.0 V, allowing the interface of 5.0 V systems to 3.0 V systems.

Features

- High Speed: $t_{PD} = 5.5 \text{ ns (Typ)}$ at $V_{CC} = 5.0 \text{ V}$
- Low Power Dissipation: $I_{CC} = 2.0 \,\mu\text{A}$ (Max) at $T_{A} = 25^{\circ}\text{C}$
- TTL-Compatible Inputs: $V_{IL} = 0.8 \text{ V}$; $V_{IH} = 2.0 \text{ V}$
- Power Down Protection Provided on Inputs
- Balanced Propagation Delays
- Designed for 2.0 V to 5.5 V Operating Range
- Low Noise: $V_{OLP} = 0.8 \text{ V (Max)}$
- Pin and Function Compatible with Other Standard Logic Families
- Chip Complexity: 60 FETs or 15 Equivalent Gates
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant



ON Semiconductor®

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MARKING DIAGRAMS



SOIC-14 D SUFFIX CASE 751A





TSSOP-14 DT SUFFIX CASE 948G



A = Assembly Location

WL, L = Wafer Lot Y, YY = Year WW, W = Work Week G or ■ = Pb-Free Package

(Note: Microdot may be in either location)

FUNCTION TABLE

Inputs	Outputs
Α	γ
L	Н
H	L

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

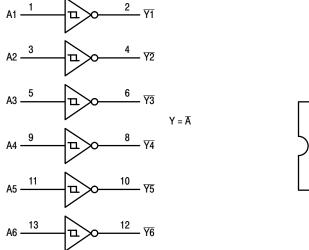
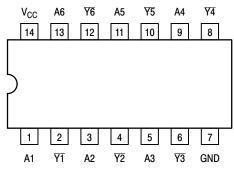


Figure 1. Logic Diagram



Pinout: 14-Lead Packages (Top View)

MAXIMUM RATINGS

	Parameter	Symbol	Value	Unit
DC Supply Voltage		V _{CC}	-0.5 to +7.0	V
DC Input Voltage		V _{IN}	-0.5 to +7.0	V
DC Output Voltage	Output in HIGH or LOW State (Note 1)	V _{OUT}	-0.5 to V _{CC} +0.5 V	V
V _{CC} = 0 V		V _{OUT}	-0.5 to 7.0	V
DC Input Diode Current		I _{IK}	-20	mA
DC Output Diode Current		I _{OK}	±20	mA
DC Output Source/Sink Current		I _O	±25	mA
DC Supply Current per Supply Pin		I _{CC}	±50	mA
DC Ground Current per Ground Pi	n	I _{GND}	±50	mA
Storage Temperature Range		T _{STG}	-65 to +150	°C
Lead Temperature, 1 mm from Cas	se for 10 Seconds	TL	260	°C
Junction Temperature under Bias		TJ	+150	°C
Thermal Resistance	SOIC TSSOP	$\theta_{\sf JA}$	125 170	°C/W
Power Dissipation in Still Air	SOIC TSSOP	P _D	500 450	mW
ESD Withstand Voltage	Human Body Model (Note 2) Machine Model (Note 3) Charged Device Model (Note 4)	V _{ESD}	>2000 >200 2000	V
Latchup Performance	Above V _{CC} and Below GND at 85°C (Note 5)	I _{Latchup}	±300	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. $I_{\rm O}$ absolute maximum rating must be observed.

- Tested to EIA/JESD22-A114-A.
- 3. Tested to EIA/JESD22-A115-A.
- 4. Tested to JESD22-C101-A.
- 5. Tested to EIA/JESD78.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Max	Unit
Supply Voltage	V _{CC}	4.5	5.5	V
Input Voltage	VI	0	5.5	V
Output Voltage (Note 6)	V _O	0	V _{CC}	V
V _{CC} = 0 V	V _O	0	5.5	V
Operating Free–Air Temperature	T _A	- 55	+125	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

6. I_O absolute maximum rating must be observed.

DC ELECTRICAL CHARACTERISTICS

			v _{cc}	T _A = 25°C		С	T _A ≤	85°C	T _A ≤ 1	125°C	
Parameter	Test Conditions	Symbol	v	Min	Тур	Max	Min	Max	Min	Max	Unit
Positive Threshold Voltage		V _{T+}	4.5 5.5			1.9 2.1		1.9 2.1		1.9 2.1	V
Negative Threshold Voltage		V _{T-}	4.5 5.5	0.5 0.6			0.5 0.6		0.5 0.6		V
Hysteresis Voltage		V _H	4.5 5.5	0.40 0.40		1.40 1.50	0.40 0.40	1.40 1.50	0.40 0.40	1.40 1.50	V
Minimum High-Level Output Voltage $I_{OH} = -50 \mu A$	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $I_{OH} = -50 \mu A$	V _{OH}	4.5	4.4	4.5		4.4		4.4		V
	$I_{OH} = -8.0 \text{ mA}$		5.5	3.94			3.80		3.66		
Maximum Low-Level Output Voltage	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $I_{OL} = 50 \mu A$	V _{OL}	4.5		0.0	0.1		0.1		0.1	V
	$I_{OL} = 8.0 \text{ mA}$		5.5			0.36		0.44		0.52	
Maximum Input Leakage Current	V _{IN} = 5.5 V or GND	I _{IN}	0 to 5.5			±0.1		±1.0		±1.0	μΑ
Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	I _{CC}	5.5			2.0		20		40	μΑ
Quiescent Supply Current	Input: V _{IN} = 3.4 V	I _{CCT}	5.5			1.35		1.50		1.65	mA
Output Leakage Current	V _{OUT} = 5.5 V	I _{OFF}	0.0			0.5		5.0		10	μΑ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 3.0 \text{ ns}$)

			T,	_A = 25°	С	T _A ≤	85°C	T _A ≤ 1	125°C	
Parameter	Test Conditions	Symbol	Min	Тур	Max	Min	Max	Min	Max	Unit
Maximum Propagation Delay, A to Y	$V_{CC} = 5.0 \pm 0.5 \text{ V} \\ C_{L} = 15 \text{ pF} \\ C_{L} = 50 \text{ pF} \\ \label{eq:C_C}$	t _{PLH} , t _{PHL}		5.5 7.0	7.6 9.6	1.0 1.0	9.0 11.0	1.0 1.0	11.5 13.5	ns
Maximum Input Capacitance		C _{IN}		2.0	10		10		10	pF
Power Dissipation Capacitance			Typical @ 25°C, V _{CC} = 5.0 V							
(Note 7)		C _{PD}	11			рF				

^{7.} C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I_{CC(OPR)} = C_{PD} • V_{CC} • f_{in} + I_{CC} / 6 (per buffer). C_{PD} is used to determine the no–load dynamic power consumption; P_D = C_{PD} • V_{CC}² • f_{in} + I_{CC} • V_{CC}.

NOISE CHARACTERISTICS (Input $t_r = t_f = 3.0 \text{ ns}$, $C_L = 50 \text{ pF}$, $V_{CC} = 5.0 \text{ V}$)

		T _A = 25°C		
Characteristic	Symbol	Тур	Max	Unit
Quiet Output Maximum Dynamic V _{OL}	V _{OLP}	0.8	1.0	V
Quiet Output Minimum Dynamic V _{OL}	V _{OLV}	-0.8	-1.0	V
Minimum High Level Dynamic Input Voltage	V _{IHD}		2.0	V
Maximum Low Level Dynamic Input Voltage	V _{ILD}		0.8	V

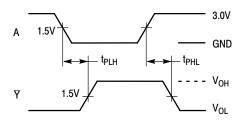
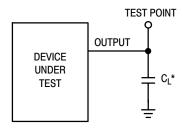


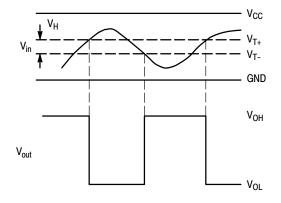
Figure 2. Switching Waveforms



*Includes all probe and jig capacitance

Figure 3. Test Circuit

(a) A Schmitt-Trigger Squares Up Inputs With Slow Rise and Fall Times



(b) A Schmitt-Trigger Offers Maximum Noise Immunity

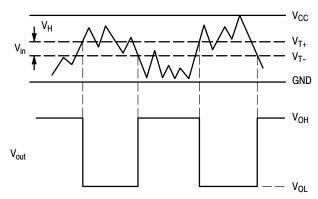


Figure 4. Typical Schmitt-Trigger Applications

ORDERING INFORMATION

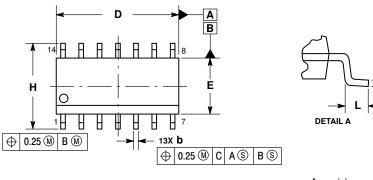
Device	Package	Shipping [†]
MC74VHCT14ADR2G	SOIC-14	
NLV74VHCT14DR2G*	(Pb-Free)	2500 / Tape & Reel
MC74VHCT14ADTR2G	TSSOP-14	2300 / Tape & Neel
NLV74VHCT14ADTR2G*	(Pb-Free)	

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

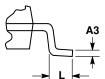
^{*}NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

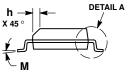
PACKAGE DIMENSIONS

SOIC-14 CASE 751A-03 ISSUE K



C SEATING PLANE





- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLING DIMENSION: MILLIMETERS.
 3. DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION, ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF AT
 - MAXIMUM MATERIAL CONDITION.

 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.

 5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	1.35	1.75	0.054	0.068
A1	0.10	0.25	0.004	0.010
A3	0.19	0.25	0.008	0.010
b	0.35	0.49	0.014	0.019
D	8.55	8.75	0.337	0.344
Е	3.80	4.00	0.150	0.157
е	1.27	BSC	0.050	BSC
I	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.019
٦	0.40	1.25	0.016	0.049
М	0 °	7°	0 °	7°

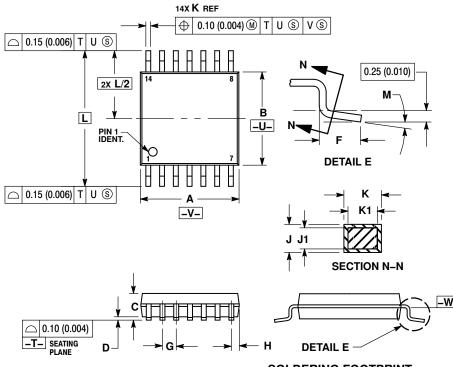
SOLDERING FOOTPRINT* 6.50 -14X 1.18 1.27 **PITCH** 14X 0.58

DIMENSIONS: MILLIMETERS

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

TSSOP-14 CASE 948G **ISSUE B**

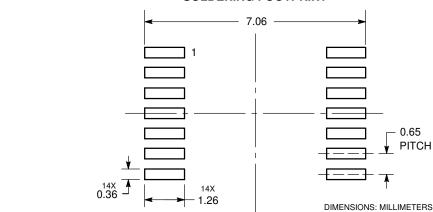


NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER. 3. DIMENSION A DOES NOT INCLUDE MOLD J. DIMENSION A DUES MOIT INCLUDE MOLD
 FLASH, PROTRUSIONS OR GATE BURRS.
 MOLD FLASH OR GATE BURRS SHALL NOT
 EXCEED 0.15 (0.006) PER SIDE.
 1. DIMENSION B DOES NOT INCLUDE
 INTERLEAD FLASH OR PROTRUSION.
 INTERLEAD FLASH OR PROTRUSION SHALL
- NOT EXCEED 0.25 (0.010) PER SIDE.
- 5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
- 6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- 7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	4.90	5.10	0.193	0.200
В	4.30	4.50	0.169	0.177
С		1.20		0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65	BSC	0.026	BSC
Н	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
Κ	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
Г	6.40 BSC		0.252	BSC
М	0 °	8 °	0°	8 °

SOLDERING FOOTPRINT



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